

Section VII: SPICE Model Parameters

Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/hit_sic/sjt/2N7639-GA_SPICE.pdf) into LTSPICE (version 4) software for simulation of the 2N7639-GA.

```
*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision: 1.3          $
*      $Date: 12-DEC-2014     $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
*      COPYRIGHT (C) 2014 GeneSiC Semiconductor Inc.
*      ALL RIGHTS RESERVED
*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
.model 2N7639-GA NPN
+ IS          9.8338E-48
+ ISE         1.0733E-26
+ EG          3.23
+ BF          110
+ BR          0.55
+ IKF         200
+ NF          1.02
+ NE          2.0
+ RB          2.6
+ IRB         0.002
+ RBM         0.16
+ RE          0.01
+ RC          0.045
+ CJC         8.2281E-10
+ VJC         3.31126
+ MJC         0.48117
+ CJE         2.33957E-9
+ VJE         2.91486
+ MJE         0.48211
+ XTI         3
+ XTB         -1.2
+ TRC1        6.20E-03
+ VCEO        600
+ ICRATING    32
+ MFG         GeneSiC_Semiconductor
*
* End of 2N7639-GA SPICE Model
```